

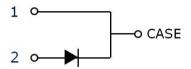
# CoolSiC™ Automotive Schottky Diode 650V G5

650V/8A Silicon Carbide Schottky Diode in D2PAK (Real 2 Pins)

#### **Features**

- Revolutionary semiconductor material Silicon Carbide
- Benchmark switching behavior
- No reverse recovery/ No forward recovery
- Temperature independent switching behavior
- High surge current capability
- Pb-free lead plating; RoHS compliant
- Junction Temperature range from -40°C to 175°C
- System efficiency improvement over Si diodes
- System cost / size savings due to reduced cooling requirements
- Enabling higher frequency / increased power density solutions
- Higher system reliability due to lower operating temperatures
- Reduced EMI





### **Potential Applications**

- Traction inverter
- Booster / DCDC Converter
- On board Charger / PFC









#### **Product Validation**

"Qualified for Automotive Applications. Product Validation according to AEC-Q100/101"

### Description

The 5th Generation CoolSiC<sup>TM</sup> Automotive Schottky Diode represents Infineon leading edge technology for Silicon Carbide Schottky Barrier diodes. Thanks to a compact design and a technology based on thin wafers, this family of products shows improved efficiency over all load conditions resulting from both its thermal characteristics and low figure of merit (Qc x Vf). This product family has been designed to complement Infineon's IGBT and CoolMOS<sup>TM</sup> portfolio. This ensures meeting the most stringent application requirements in the 650V voltage class.

Product Information				
Ordering Code	AIDK08S65C5			
Marking	AD0865C5			
Package	PG-TO263-2-1			
SP Number	SP001725146			

Parameter	Value/Unit
$V_{DC,max}$	650 V
I <sub>F</sub> ; T <sub>C</sub> < 126 °C	8 A
$Q_{C}$ ; $V_{R}$ = 400 V	13 nC
E <sub>C</sub> ; V <sub>R</sub> = 400 V	2.8 μJ
$T_{j,max}$	175 °C

Pin	Definition
Pin 1,case	Cathode
Pin 2	Anode



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**Maximum Ratings** 

# 1 Maximum Ratings

### Table 1 Maximum ratings<sup>1</sup>

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	650	V
Continuous forward current for $R_{thJC,max}$ $T_C = 126  ^{\circ}C$ , D=1	I <sub>F</sub>	8	А
Surge non-repetitive forward current, sine halfwave $T_C=25^{\circ}C$ , $t_p=10ms$ $T_C=150^{\circ}C$ , $t_p=10ms$	I <sub>F,SM</sub>	35 25	A
Non-repetitive peak forward current $T_C=25^{\circ}C,t_p=10\mu s$	I <sub>F,max</sub>	364	А
$i^2$ t value $T_C = 25$ °C, $t_p = 10$ ms $T_C = 150$ °C, $t_p = 10$ ms	∫i² dt	6 3	A <sup>2</sup> s
Diode dv/dt ruggedness V <sub>R</sub> =0480V	dv/dt	100	V/ns
Power dissipation $T_C = 25^{\circ}C$	P <sub>tot</sub>	43	W
Operating temperature	T <sub>j</sub>	-40175	°C
Storage temperature	$T_{stg}$	-55150	°C
ESD			
Human body model, R= 1.5 k $\Omega$ , C = 100 pF		8	kV
Charged device model		2	



**Thermal Characteristics** 

# 2 Thermal Characteristics

### Table 2 Thermal Characteristics<sup>1</sup>

Darameter	Symbol	Values			Unit	Note/Test condition
Parameter		Min.	Тур.	Мах.	Unit	Note/Test condition
Thermal resistance, junction–case <sup>2</sup>	$R_{thJC}$	-	2.7	3.5	K/W	
Thermal resistance, junction-ambient <sup>2</sup>	R <sub>thJA</sub>	-	-	62	K/W	



#### **Electrical Characteristics**

### 3 Electrical Characteristics

#### Table 3 Static Characteristics

Parameter	C: mah al	Values			l lmit	Note/Test condition
Parameter	Symbol	Min.	Тур.	Мах.	Unit	Note/Test condition
DC blocking voltage	V <sub>DC</sub>	650	-	-		$T_j = 25$ °C, $I_R = 0.05$ mA
Diode forward voltage <sup>3</sup>	V <sub>F</sub>	-	1.5	1.7	V	$T_j = 25^{\circ}C, I_F = 8 A$
		-	1.8	2.1		$T_j = 150$ °C, $I_F = 8$ A
Reverse current	I <sub>R</sub>	-	1	50		V <sub>R</sub> = 650 V, T <sub>j</sub> = 25 °C
		-	9	-	μΑ	V <sub>R</sub> = 650 V, T <sub>j</sub> = 150 °C

Table 4 Dynamic Characteristics at Tj=25°C unless noted otherwise

Davamatav	Symbol	Values			Unit	Note /Test condition
Parameter		Min.	Тур.	Мах.	Unit	Note/Test condition
Total capacitive charge	Q <sub>c</sub>	-	13	-	nC	$V_R = 400 \text{ V}, \text{ di/dt} = 200 \text{ A/}\mu\text{s},$ $I_F \le I_{F,MAX}, T_j = 150 \text{ °C}$
Total capacitance	С	-	248	-	pF	V <sub>R</sub> = 1 V, f = 1 MHz
		-	33	-		V <sub>R</sub> = 300 V, f = 1 MHz
		-	32	-		V <sub>R</sub> = 600 V, f = 1 MHz

#### Footnotes:

<sup>&</sup>lt;sup>1</sup> The parameter is not subject to production test- verified by design/characterization.

<sup>&</sup>lt;sup>2</sup> Rth,JC defined as per JESD-51-14. Rth,JA defined as per JESD-51-5/7.

<sup>&</sup>lt;sup>3</sup> Only the value at 25°C is subject to production test. The value at 150°C is only verified by design/characterization.



**Electrical Characteristics Diagrams** 

### 4 Electrical Characteristics Diagrams

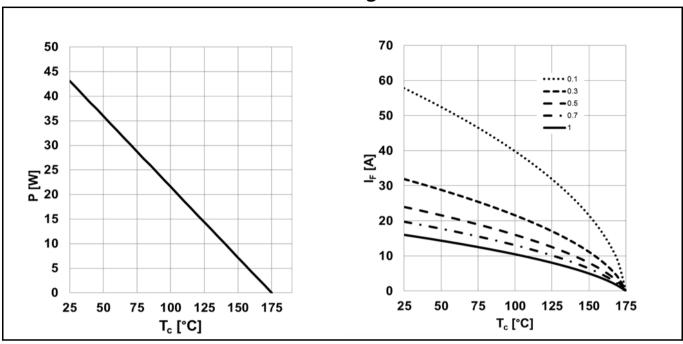


Figure 1 (LEFT) Power dissipation;  $P_{tot} = f(T_c)$ ;  $R_{thJC,max}$  (RIGHT) Diode forward current;  $I_F = f(T_c)$ ;  $T_i \le 175$  °C;  $R_{thJC,max}$ ; parameter: D=duty cycle

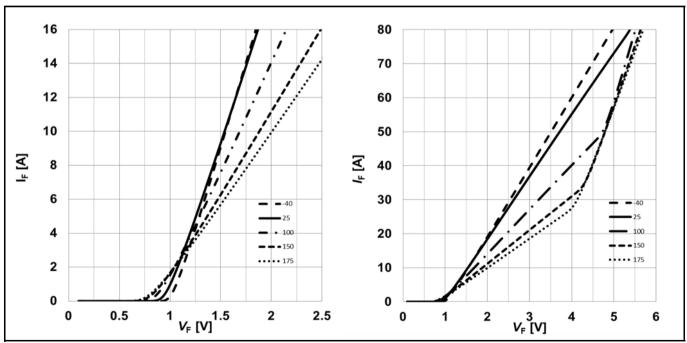


Figure 2 (LEFT) Typical forward characteristic;  $I_F = f(V_F)$ ;  $t_P = 20 \mu s$ ; parameter: $T_j$  (RIGHT) Typical forward characteristics in surge current;  $I_F = f(V_F)$ ;  $t_P = 20 \mu s$ ; parameter: $T_j$ 



#### **Electrical Characteristics Diagrams**

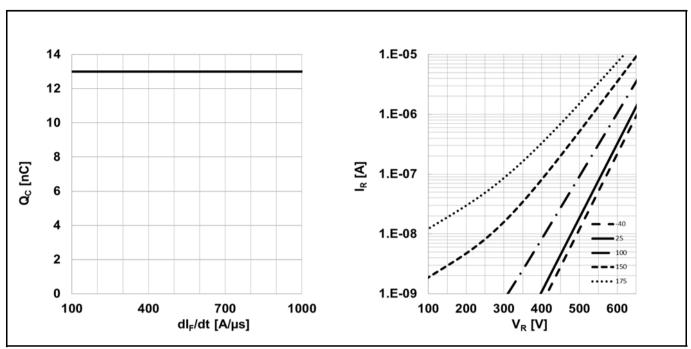


Figure 3 (LEFT) Typical capacitive charge versus current slope (only capacitive charge, guaranteed by design);  $Q_C = f(di_F/dt)$ ;  $T_j = 150^{\circ}C$ ;  $V_R = 400V$ ;  $I_F \le I_{F,max}$  (RIGHT) Typical reverse current versus reverse voltage;  $I_R = f(V_R)$ ; parameter:  $T_i$ 

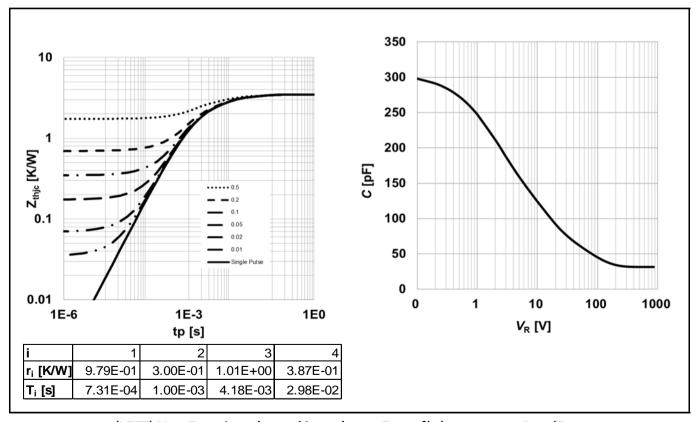


Figure 4 (LEFT) Max. Transient thermal impedance;  $Z_{thJC} = f(t_p)$ ; parameter:  $D = t_p/T$  (RIGHT) Typ. Capacitance vs. Reverse voltage;  $C = f(V_R)$ ;  $T_i = 25^{\circ}C$ ; f = 1 MHz



#### **Electrical Characteristics Diagrams**

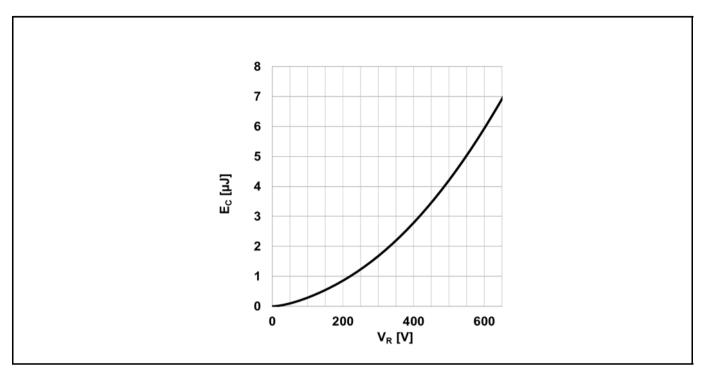


Figure 5 Typical capacitance stored energy;  $E_C = f(V_R)$ 

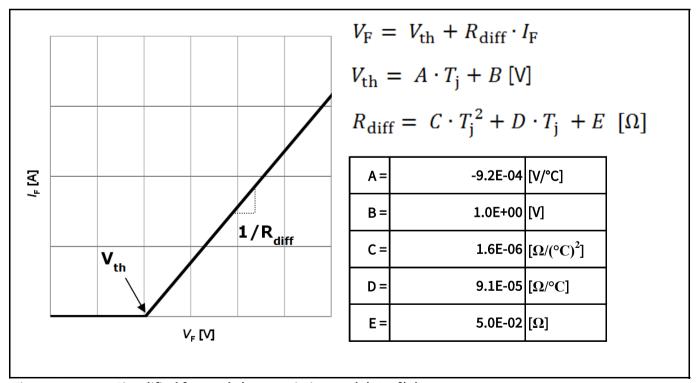


Figure 6 Simplified forward characteristics model  $V_F = f(I_F)$ ; -40°C <  $T_i$  < 175°C;  $I_F$  < 16 A



**Package Outlines** 

# 5 Package Outlines

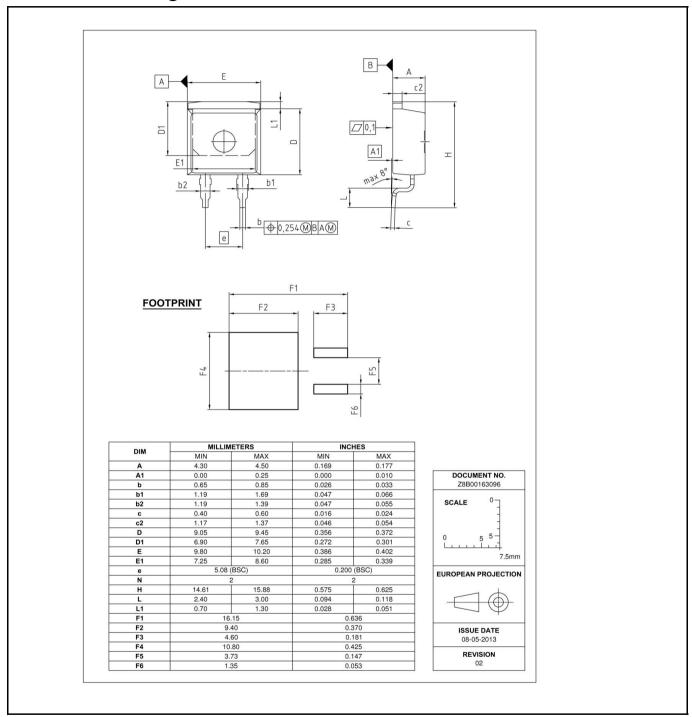


Figure 6 Package outline of PG-TO263-2-1 leaded



**Revision History** 

# **Revision History**

Document Version	Date of Release	Description of changes			
V3.0	11.06.2019	1st release of Data Sheet			



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**Document reference** 

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